PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
CHEN-YU LIU	05/30/2016
CHING-YU CHANG	05/30/2016

RECEIVING PARTY DATA

Name:	TAIWAN SEMICONDUCTOR MANUFACTURING CO., LTD.	
Street Address:	NO. 8, LI-HSIN ROAD 6,	
Internal Address:	Idress: SCIENCE-BASED INDUSTRIAL PARK	
City:	HSIN-CHU	
State/Country:	e/Country: TAIWAN	
Postal Code:	300-77	

PROPERTY NUMBERS Total: 1

Property Type	Number	
Application Number:	15182160	

CORRESPONDENCE DATA

Fax Number: (214)651-5940

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

214-651-5000 Phone:

Email: ipdocketing@haynesboone.com

HAYNES AND BOONE. LLP IP SECTION **Correspondent Name:**

Address Line 1: 2323 VICTORY AVENUE

Address Line 2: SUITE 700

Address Line 4: DALLAS, TEXAS 75219

ATTORNEY DOCKET NUMBER: 24061.3347US01 NAME OF SUBMITTER: LADONNA JOHNSON SIGNATURE: /LADONNA JOHNSON/ **DATE SIGNED:** 06/14/2016

Total Attachments: 2

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> **PATENT** REEL: 038911 FRAME: 0366

503870825

Docket No.: P20151419US00/24061.3347US01

Customer No.: 000042717

ASSIGNMENT

WHEREAS, we,

(1)	Chen-Yu Liu	of	Kaohsiung City, Taiwan (R.O.C)
(2)	Ching-Yu Chang	of	Yilang County, Taiwan (R.O.C.)

have invented certain improvements in

EXTREME ULTRAVIOLET LITHOGRAPHY WITH REDUCED EXPOSURE DOSE AND NEGATIVE TONE DEVELOPMENT

for which we have executed an application for Letters Patent of the United States of America,

of even date filed herewith; and

The states of America,

of even date filed herewith; and
filed on 06-14-2016 and assigned application number 15/182,160; and

WHEREAS, we authorize the attorney of record to update this document to include Patent Office information as deemed necessary (i.e., filing date, serial number, etc.);

WHEREAS, Taiwan Semiconductor Manufacturing Co., Ltd., ("TSMC"), No. 8, Li-Hsin Rd. 6, Science-Based Industrial Park Hsin-Chu, Taiwan 300-77, Republic of China. is desirous of obtaining the entire right, title, and interest in, to and under the said invention and the said application in the United States of America and in any and all countries foreign thereto;

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, and other good and valuable consideration, we have sold, assigned, transferred and set over, and by these presents do hereby sell, assign, transfer and set over, unto the said TSMC, its successors, legal representatives, and assigns, the entire right, title, and interest in, to and under the said invention, and the said application, and all divisional, renewal, substitutional, and continuing applications thereof, and all Letters Patent of the United States of America which may be granted thereon and all reissues and extensions thereof, and all applications for Letters Patent which may be filed for said invention in any country or countries foreign to the United States of America, and all extensions, renewals, and reissues thereof, and all prior patents and patent applications from which a filing priority of the above-described patent application may be obtained, including the right to collect past damages; and we hereby authorize and request the Commissioner of Patents of the United States of America, and any official of any country or countries foreign to the United States of America, whose duty it is to issue patents on applications as aforesaid, to issue all Letters Patent for said invention to the said TSMC, its successors, legal representatives and assigns, in accordance with the terms of this instrument.

AND WE HEREBY covenant that we have full right to convey the entire interest herein assigned, and that we have not executed, and will not execute, any agreement in conflict herewith.

AND WE HEREBY further covenant and agree that we will communicate to said TSMC, its successors, legal representatives and assigns, any facts known to us respecting said invention, and testify in any legal proceedings, sign all lawful papers, execute all divisional, renewal, substitutional, continuing, and reissue applications, make all rightful declarations and/or oaths

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and generally do everything possible to aid the said TSMC, its successors, legal representatives and assigns, to obtain and enforce proper patent protection for said invention in all countries.

Inventor Name: Chen-Yu Liu

Residence Address:

No. 4, Ln. 480, Dafeng 1st Rd., Sanmin

Dist., Kaohsiung City 807, Taiwan, Republic of China

Dated: 2016/5/30

Inventor Name: Ching-Yu Chang

Residence Address:

No. 17, Hsinchen Road, Yuansun Village

Yilang County, Taiwan 264, Taiwan, Republic of China

Dated: \$720 2016

Inventor Signature

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RECORDED: 06/14/2016

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